

Part Number: XZMOK78W

3.2 x 2.4 mm SMD Chip LED Lamp

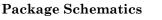
Features

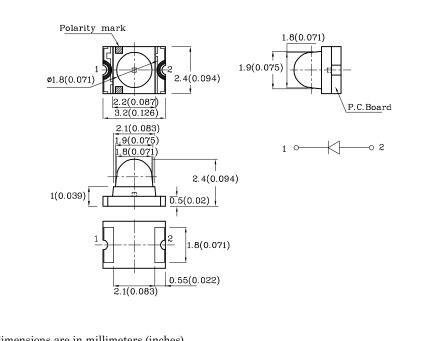
- Ideal for indication light on hand held products
- Long life and robust package
- Standard Package: 1,500pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- Halogen-free
- RoHS compliant





ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES





1. All dimensions are in millimeters (inches).

Notes:

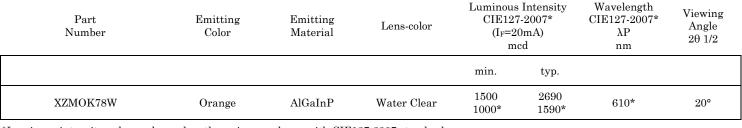
2. Tolerance is $\pm 0.1(0.004")$ unless otherwise noted.

3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)		Orange (AlGaInP)	Unit
Reverse Voltage	$V_{\rm R}$	5	V
Forward Current	$I_{\rm F}$	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	195	mA
Power Dissipation	\mathbf{P}_{D}	75	mW
Operating Temperature	$T_{\rm A}$	$-40 \sim +85$	°C
Storage Temperature	Tstg	-40 ~ +85	

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Characteristics (T _A =25°C)		Orange (AlGaInP)	Unit
Forward Voltage (Typ.) (I _F =20mA)	V_{F}	2.1	V
Forward Voltage (Max.) (I _F =20mA)	V_{F}	2.5	V
Reverse Current (Max.) (V _R =5V)	I_R	10	μΑ
Wavelength of Peak Emission CIE127-2007* (Typ.) (I _F =20mA)	λP	610*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I _F =20mA)	λD	605*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	$ riangle \lambda$	29	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	15	pF

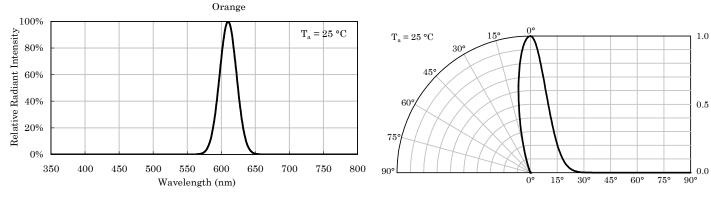


*Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

Nov 30,2020

XDSA3458 V8-X Layout: Maggie L.

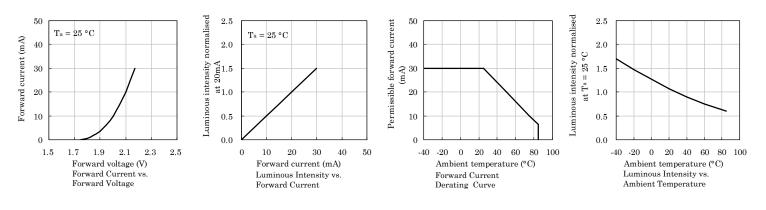




Relative Intensity Vs. CIE Wavelength

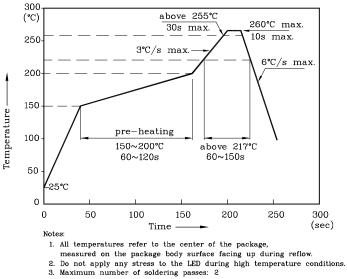


✤ Orange



LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)

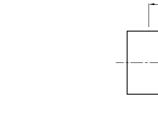


XDSA3458 V8-X Layout: Maggie L.

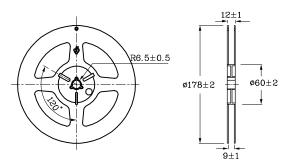


✤ The device has a single mounting surface. The device must be mounted according to the specifications.

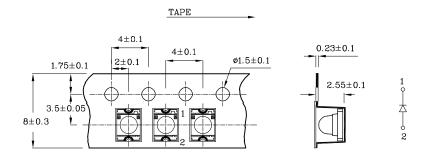
Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



✤ Reel Dimension (Units : mm)



Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

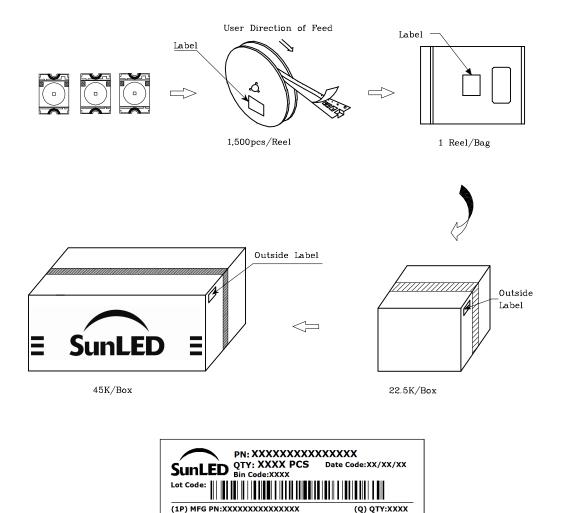
2. Luminous intensity / luminous flux: +/-15%

3. Forward Voltage: +/-0.1V $\,$

Note: Accuracy may depend on the sorting parameters.



PACKING & LABEL SPECIFICATIONS



TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet.

(9D)

COO:CN

(SP)XXXXXXXXXX

(33P) BIN CODE:XXXX

RoHS Complian Made in China

D/C:XXXX

- User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
- 5. The contents within this document may not be altered without prior consent by SunLED.
- 6. Additional technical notes are available at https://www.SunLEDusa.com/TechnicalNotes.asp